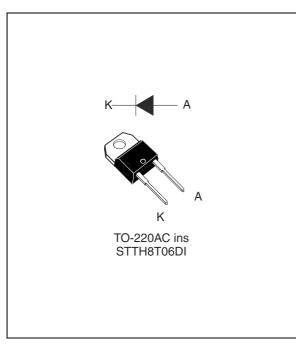


### 600 V tandem extra fast diode

Datasheet - production data



**Table 1. Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	8 A
V <sub>RRM</sub>	600 V
t <sub>rr</sub> (typ)	15 ns
I <sub>RM</sub> (typ)	2.3 A
V <sub>F</sub> (typ)	2.05 V
I <sub>FRM)</sub>	40 A
T <sub>j</sub> (max)	175 °C

#### **Features**

- · High voltage rectifier
- Tandem diodes in series
- · Very low switching losses
- Insulated device with internal ceramic
- Equal thermal conditions for both 300 V diodes
- Static and dynamic equilibrium of internal diodes are warranted by design
- Insulated package:
  - Capacitance: 7 pF
  - Insulated voltage: 2500 V rms

## **Description**

This device is part of ST's second generation of 600 V tandem diodes. It has ultralow switching-losses with a minimized  $Q_{RR}$  (6 nC) that makes it perfect for use in circuits working in hard-switching mode. In particular the  $V_F/Q_{RR}$  trade-off positions this device between standard ultrafast diodes and silicon-carbide Schottky rectifiers in terms of price/performance ratio.

The device offers a new positioning giving more flexibility to power-circuit designers looking for good performance while still respecting cost constraints.

Featuring ST's Turbo 2 600 V technology, the device is particularly suited as a boost diode in continuous conduction mode power factor correction circuits.

Characteristics STTH8T06

## 1 Characteristics

Table 2. Absolute ratings (limiting values at T<sub>i</sub> = 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub> Repetitive peak reverse voltage	Denetitive modely various voltages	T <sub>j</sub> from 25 to 150 °C	600	\
	Repetitive peak reverse voltage	T <sub>j</sub> = -40 °C	550	V
I <sub>F(RMS)</sub>	Forward rms current	14	Α	
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$	8	Α	
I <sub>FSM</sub>	Surge non repetitive forward current	80	Α	
I <sub>FRM</sub>	Repetitive peak forward current	40	Α	
T <sub>stg</sub>	Storage temperature range	-65 to +175	°C	
Tj	Operating junction temperature	-40 to +175	°C	

**Table 3. Thermal parameters** 

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	2.8	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	V- <b>-</b> V			10	μA
Reverse leakage current	T <sub>j</sub> = 125 °C	$V_R = V_{RRM}$		30	300	μΛ	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 8 A		2.95		V
VF` ′	Forward voltage drop	T <sub>j</sub> = 150 °C	IF = 0 A		2.05	2.55	V

- 1. Pulse test:  $t_p = 5 \text{ ms}, \delta < 2\%$
- 2. Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.75 \text{ x } I_{F(AV)} + 0.10 I_{F}^{2}_{(RMS)}$$

STTH8T06 Characteristics

**Table 5. Dynamic characteristics** 

Symbol	Parameter	Test conditions			Тур.	Max.	Unit
	t <sub>rr</sub> Reverse recovery time	T _ 25 °C	$I_F = 1 \text{ A}, V_R = 30 \text{ V},$ $dI_F/dt = -50 \text{ A}/\mu\text{s}$		23	30	
t <sub>rr</sub>			I <sub>F</sub> = 8 A, V <sub>R</sub> = 400 V, dI <sub>F</sub> /dt = -200 A/μs		15	20	ns
	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 8 A, V <sub>R</sub> = 400 V, dI <sub>F</sub> /dt = -200 A/μs		22			
1	I <sub>RM</sub> Reverse recovery current  S Softness factor	T <sub>j</sub> = 25 °C			0.8	1.1	Α
'RM		T <sub>j</sub> = 125 °C			2.3	3	^
S		T <sub>j</sub> = 25 °C	$I_F = 8 \text{ A}, V_R = 400 \text{ V},$		1.6		
3 Sollifess factor	T <sub>j</sub> = 125 °C	dI <sub>F</sub> /dt = -200 A/μs		0.8		-	
0	Davoras rassueru aharas	T <sub>j</sub> = 25 °C			6		nC
Q <sub>RR</sub>	Reverse recovery charge	T <sub>j</sub> = 125 °C			28		110

Figure 1. Average forward power dissipation versus average forward current

Figure 2. Forward voltage drop versus forward current (typical values)

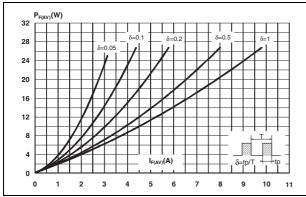
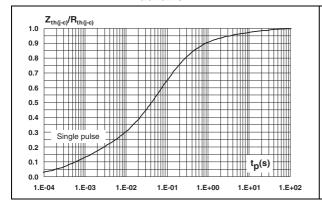
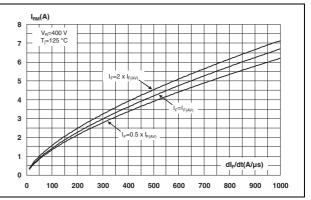


Figure 3. Relative variation of thermal impedance, junction to case, versus pulse duration

Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)





Characteristics STTH8T06

Figure 5. Reverse recovery time versus dl<sub>F</sub>/dt (typical values)

t<sub>RR</sub>(ns) 50 V<sub>R</sub>=400 V T<sub>j</sub>=125 °C 40 30 10 dl<sub>F</sub>/dt(A/μs) 0 0 600 700 800 200 300 400 500

Figure 6. Reverse recovery charges versus dl<sub>F</sub>/dt (typical values)

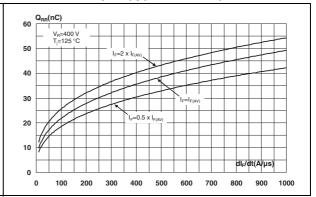


Figure 7. Reverse recovery softness factor versus dl<sub>F</sub>/dt (typical values)

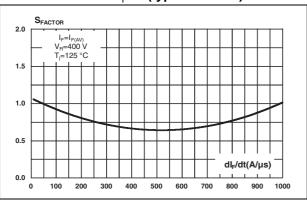


Figure 8. Relative variations of dynamic parameters versus junction temperature

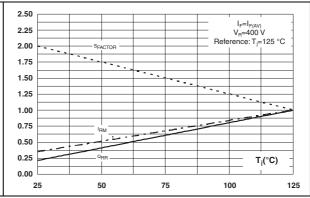
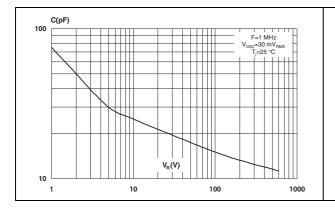
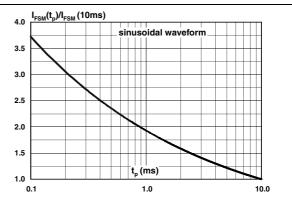


Figure 9. Junction capacitance versus reverse voltage applied (typical values)

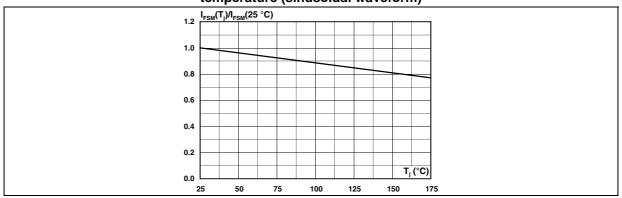
Figure 10. Relative variation of non-repetitive peak surge forward current versus pulse duration





STTH8T06 Characteristics

Figure 11. Relative variation of non-repetitive peak surge forward current versus initial junction temperature (sinusoidal waveform)



Package information STTH8T06

## 2 Package information

• Epoxy meets UL94, V0

• Cooling method: by conduction (C)

Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Figure 12. T0-220AC ins dimension definitions

STTH8T06 Package information

Table 6. T0-220AC ins dimension values

			Dime	ensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
В	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
С	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
е	4.80		5.40	0.189		0.212
F	6.20		6.60	0.244		0.259
ØI	3.75		3.85	0.147		0.151
14	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
М		2.60			0.102	

Ordering information STTH8T06

# 3 Ordering information

**Table 7. Ordering information** 

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH8T06DI	STTH8T06DI	TO-220AC ins	2.30 g	50	Tube

# 4 Revision history

Table 8. Document revision history

Date	Revision	Changes
16-Oct-2012	1	Initial release
07-Nov-2012	2	Expanded description section
11-Apr-2013	3	Added Figure 10 and Figure 11.

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